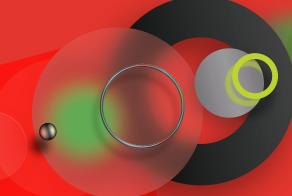
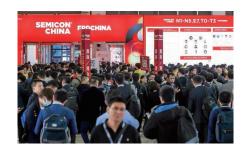
SEMICON® Co-located with FPDCHINA 20-22 March, 2024 SNIEC | SHANGHAI, CHINA



2024 POST-SHOW REPORT





- The Largest scale: The exhibit space reached a new record high 90,000 square meters, with about 1,100 exhibitors, and over 4,500 booths. The event covered the entire electronics supply chain including chip design, manufacturing, assembly and test, equipment and materials, PV and display.
- Top notch leadership: The keynote speeches featured world-class industry leaders, who explored global business, technology, market trend and hot investment topics.
- Concurrent forums: Include "ISS: SEMI Innovation & Investment (SIIP China)". "Automotive IC", "Smart Manufacturing", "Advanced Material", "Power & Compound" and "China Display Conference", etc. CSTIC 2024 continues as the most influential international microelectronics technical conference in China. The "Heterogeneous Integration (Advanced Packaging) International Conference" was a new addition this year.
- Theme pavilions: Combine with the characteristics of China's semiconductor industry and the development trend of the global semiconductor industry, including the following hot topics IC Manufacturing, Compound Semiconductor, Smart Mobility, Advanced Material, Micro-led and SEMI Workforce Development.



REGISTRATION





GLOBAL ATTENDANCE

Total SEMICON China/FPD China Global Visitors			5,607
Taiwan Region	32%	South Korea	27%
Japan	15%	Singapore	6%
Others	6%	Russia	5%
Malaysia	3%	Hong Kong SAR	3%
USA	3%		



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FPDCHINA

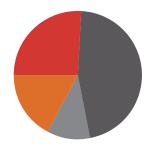


VISITOR PROFILE

SEMICON China and FPD China attract a highly influential audience from every segment and sector of the global microelectronics industries, including semiconductors, LEDs, OLEDs, MEMS, flexible hybrid electronics, and other adjacent markets.

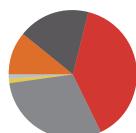


INFLUENTIAL BUYERS



PURCHASING AUTHORITY

- 26% Final Decision Maker/Co-Deciding/Crucial
- 46% Recommend/Evaluate/Consult
- 11% Specify
- 17% No Role



JOB LEVELS

- 11% Executive Management
- 18% Senior Management
- 39% Other Management
- 30% Non-Management
- 1% Student
- 1% Other

involved in purchasing decisions

represent engineering functions

PRIMARY JOB FUNCTIONS

R&D

SEMICON China and FPD China attract multi-level buying teams, with broad representation across all levels, functions and industries.

Design	7%
Equipment Engineering	7%
Product Management	6%
Fabrication and Process Enginering	5%
Test	3%
Packaging/Assembly	3%
Chemicals/Materials	2%
Facilities/Engineering Support	2%
Quality Assurance/Failure Analysis/Reliability	1%
Industrial Engineering	1%
Software Engineering	1%
Marketing, Sales, Business Development	18%
Purchasing/Procurement/Office Management	6%
Financial/Industry Analyst/Investor Relations	5%
Manufacturing/Operations Management/Production	3%
Executive Management/Board Member	3%
Logistics/Supply Chain Management	3%
Government/Public Policy	2%
Integration/IT Support	<1%
Human Resources	<1%
Environment, Health & Safety (EHS)	<1%
Training/Education	<1%
Other job function	6%



15%

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Co-located with FPDCHINA



AREA OF INTEREST

SEMICON China and FPD China is expanding to meet the needs of an increasingly interconnected and global electronic industry. Visitors are interested in a broad range of industries, technologies, and products from across the extended electronics supply chain with diverse, but interrelated interests.

INDUSTRIES SERVED

Semiconductor	30%
MEMS	11%
Sensors	15%
Imaging	6%
Flexible Hybrid Electronics/ Printed Electronics	6%
LED/Solid State Lighting	8%
Photonics	14%
Display/FPD	11%
Photovoltaic/Solar	13%
Software/Applications	5%
Consumer Electronics	9%
PCB Manufacturing	6%
PCB Assembly	5%
EMS/Contract Manufacturing/ Precision Engineering	11%
Automotive/Transportation	7%
Medical	6%
Aerospace	5%
Professional Services/Consulting	5%
Academia/University/R&D	3%
Media/Publication	1%
Association/Non-profit	1%
Government	2%
Others	7%



INFLUENTIAL BUYERS

MANUFACTURING TECHNOLO	GIES		
Design/EDA/IP	37%	Material Engineering/Materials Science	33%
Front-end Manufacturing		System-level manufacturing	17%
(IDM, foundry)	50%	Board-level manufacturing	10%
Test	37%	System Integration/Product-level	
Packaging/Assembly	41%	manufacturing	17%
Roll-to-Roll/Printing	9%	Other manufacturing	13%
APPLICATION INTERESTS			
Smart Manufacturing	30%	Mobile Technologies/Wireless/5G	13%
Virtual Reality/Augmented Reality		Consumer Electronics	22%
(VR/AR)	23%	OLED	13%
Artificial Intelligence Systems (AI)	37%	Green Manufacturing/EHS	10%
Automotive Electronics/Smart		Cloud Computing/	
Transportation	30%	High-Performance Computing	11%
Internet of Things (IoT)	19%	Imaging	7%
Wearables	18%	Other applications	13%
Medical Electronics/MedTech	15%		

Design/EDA	33%	Factory Control/Process Software	17%
Fabless	26%	Manufacturing Services and	
Foundries	44%	Consulting	19%
Packaging & Test Services (OSAT)	33%	Engineering Services	13%
Electronic Manufacturing Services (EMS)/	R&D/Technology Transfer	11%
System Integration	17%	Other design/manufacturing services	13%

MANUFACTURING EQUIPMENT

Front-end Processing Printing/Coating/Roll-to-Roll Large-area/Thin Film	15%	Factory Automation/Robotics Abatement/Environmental Systems Components/Sub-systems/	18% 7%
Inspection & Measurement/ Metrology	18%	Instrumentation Parts	11% 17%
Test	26%	Secondary Equipment and Services	9%
Assembly/Packaging	27%	Other manufacturing equipment	15%

MATERIALS

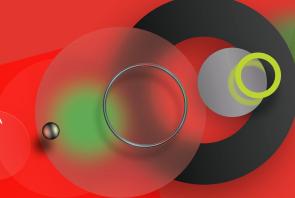
Inks/Pastes/Printing Materials	10%	Other materials	16%
Solids/Chemicals	31%	Consumables	10%
Process materials: Gases/Liquids/		Packaging/Assembly	24%
Wafers/Substrates	47%	Cleaning	15%

OTHER

Support Products/Cleanroom	20%	Standards	8%
General Business Services/Consulting	12%	Other	15%
Representative Sales and Service	13%		



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2024 POST-SHOW REPORT

Sessions and Events



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Grand Opening Keynote



SEMI Industry Strategy Symposium (ISS): SEMI Innovation and Investment Forum (SIIP China)



Design Innovation Forum -Automotive IC



SEMI Workforce CXO Talent Forum



SCC Carbon Neutrality **265** and Sustainable Development Summit Forum



Heterogeneous Integration (Advanced Packaging) International Conference (HIIC)



Power & Compound Semiconductor International Forum



IC Manufacturing International Forum



Advanced Material Conference(AMC)

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Smart Manufacturing Forum -Factory of the Future



Green High-Tech Facility 158 International Forum



CDC Metaverse -Display on Silicon

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Conference of Science & Technology for Integrated Circuits



March 26 - 28 2025 SNIEC, Shanghai



SEMI微信公众号